| IPC ASSOCIATION ELECTRONIC | © Copyri | Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reservational and Pan-American copyright conventions. | | | all rights reserved untions. | under both | This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly valued parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsit | | | | | | | | ssembly with low responsibility. | |
|----------------------------|--|---|------------|--|------------------------------|---------------|---|-------------------------------|------------|----------|--------------|---------------------------------|------------------|------------------|-------------------------------------|---|
| 752-21.1 | | | | | Form Type Distribute | | | | | | neous Materi | rials and Mfg Information | | | | |
| Supplier | r Information | | | | | | | | | | | | | | | |
| Company name* Compan | | | | Company uni | mpany unique ID | | | Unique ID Authority | | | | | Response Date* | | | |
| nsemi | | | | | | | | | | | | | 2024-05-17 | | | |
| Contact Name | | | | Title - Contact | | | 1 | Phone - Contact* | | | | | Email - Contact* | | | |
| Product-I | Env-Stewards | | I | Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| Authorized Representative* | | | | Title - Representative | | |] | Phone - Representative* | | | | Email - Representative* | | | | |
| Product-Env-Stewards | | | | Product Enviro Compliance | | | | NA | | | | Product-Env-Stewards@onsemi.com | | | | |
| | Requester Item Num | Requester Item Number Mfr Iter | | m Number Mfr Item Name | | | | Effective Da | ctive Date | | uring Site | W | eight* | UOM | Unit Type | |
| | | N | NCV87028 | CV8702SN18T1G 200 mA LDO, Ultra Ultra-Low Noise | | | 10 mA, | 2024-05-17 | | | 14 | .08 | mg | Each | | |
| Ianufa | cturing Process | Information | | | | | | | | | | | | | | |
| | Terminal Plating / Grid Array Material | | | Ferminal Base Alloy J-STD-020 MS | | J-STD-020 MSL | Rating | Peak Process Body Temperature | | re Max 7 | Γime at Peak | Temperatur | e Num | ber of Reflow Cy | cles | |
| Matte Tin (Sn) - annealed | | | CU | CU Alloy 1 | | | 260 C 30 | | 30 | | seconds 3 | | | | | |
| omments | 3 | · | | · | · | · | | | | | | · | | | · | |
| vel 1 - m | aximum time at peak | temperature du | ring solde | ering is 10-3 | 0 seconds | | | | | | | | | | | |
| or more | information regardin | g material comp | osition pl | ease refer to | page 3 | | | | | · | | | | | | · |

| RoHS Material Composition Declaration | | | Declaration Type * | Detail | ed |
|--|---|---|---|---|---|
| Directive 2015/863/EU amending RoHS Directive 2011/65/EU | | ium (Cr6+), Polybrominated Biphenyls (PB) | erial for Cadmium and quantity limit of 0.1% b B), Polybrominated Diphenyl Ethers (PBDE), a | | |
| cadmium, hexavalentchromium, polybromin contains a RoHS restricted substance inexce encompass all such components. Supplier cet as of the date that Supplier completes this Company acknowledges that Supplier may hindependently verified information provided certification in this paragraph. If the Compan | nated biphenyls and/or polybrominated diphess of an applicable quantity limit, please indriffes that it gathered the information it provom. Supplier acknowledges that Company wave relied on informationprovided by others of the supplier agrees that, at a minimusy and the Supplier enter into a written agree yesource of the Supplier's liability and the C | enyl ethers (each a "RoHS restricted substan licate below which, if any, RoHS exemption vides in this form using appropriate methods vill rely on this certification in determining the s in completing this form, and that Supplier um, itssuppliers have provided certifications ement with respect to the identified part, the tompany's remedies for issues that arise rega | s of the European Union member states) of the ce") in excess of the applicable quantity limit is you believe may apply. If the part is an assemb to ensure its accuracy and that such informatio e compliance of its products with European Ur may not have independently verified such infor regarding their contributions to the part, and the erms and conditions of that agreement, including information the Supplier provides in this | dentified above. If a ally with lower level in is true and correct at it in member state la mation. However, in ose certifications are ag any warranty righ | homogeneous material within the part components, the declaration shall to the best of its knowledge and belief, was that implement the RoHS Directive. In situations where Supplier has not the at least as comprehensive as the lats and/or remedies provided as part of |
| RoHS Declaration * 1 - Item | (s) does not contain RoHS restricted substar | nces per the definition above | Supplier A | cceptance * | Accepted |
| Exemption: If the declared item does not applicable exemptions. | contain RoHS restricted substances per t | he definition above except for defined Rol | IS exemptions, then select the corresponding | response in the R | oHS Declaration above and choose all |
| Exemption List Version | EL-2011/534/EU | | | | |
| Declaration Signature | | | | | |
| | | | | | |
| | | e "Accepted" on the Supplier Acceptance | drop-down. This will display the signature a | rea. Digitally sign t | the declaration (if required by the |

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

| Homogeneous Material | Weight | Unit of Measure | Level | Substance | CAS | Exempt | Weight | Unit of Measure |
|----------------------|--------|-----------------|----------|----------------------------|------------------|--------|--------|-----------------|
| Die | 0.42 | mg | Supplier | Silicon (Si) | 7440-21-3 | | 0.42 | mg |
| Die Attach | 0.11 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.088 | mg |
| | | | Supplier | Phenolic Resin-2 | 54208-63-8 | | 0.022 | mg |
| Lead Frame | 5.78 | mg | Supplier | Silver (Ag) | 7440-22-4 | | 0.0705 | mg |
| | | | Supplier | Zinc (Zn) | 7440-66-6 | | 0.0069 | mg |
| | | | Supplier | Iron (Fe) | 7439-89-6 | | 0.1358 | mg |
| | | | Supplier | Copper (Cu) | 7440-50-8 | | 5.565 | mg |
| | | | Supplier | Phosphorus (P) | 7723-14-0 | | 0.0017 | mg |
| Mold Compound-Black | 7.34 | mg | | Epoxy resin | proprietary data | | 0.367 | mg |
| | | | Supplier | Phenolic Resin | Proprietary Data | | 0.367 | mg |
| | | | Supplier | Ortho Cresol Novolac Resin | 29690-82-2 | | 0.1468 | mg |
| | | | Supplier | Carbon Black (C) | 1333-86-4 | | 0.0367 | mg |
| | | | Supplier | Fused Silica (SiO2) | 60676-86-0 | | 6.4225 | mg |
| Plating | 0.39 | mg | Supplier | Tin (Sn) | 7440-31-5 | | 0.39 | mg |
| Wire Bond - Au | 0.04 | mg | Supplier | Gold (Au) | 7440-57-5 | | 0.04 | mg |